

PTC thermistors for overcurrent protection

Leaded disks, coated, 63 V

Series/Type: B599*0

Date: February 2012

The following products presented in this data sheet are being withdrawn.

Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B59930C0080A070	B59930C0120A070 or B59950C0120A070	2013-05-03	2014-06-01	2014-09-01

For further information please contact your nearest EPCOS sales office, which will also support you in selecting a suitable substitute. The addresses of our worldwide sales network are presented at www.epcos.com/sales.

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Leaded disks, coated, 63 V

C910 ... C990

Applications

- Overcurrent protection
- Short circuit protection

Features

- Lead-free terminals
- Wide range of rated currents: 30 mA up to 1 A
- Marking: Type, manufacturer's logo, reference temperature in °C and date code YYWW (except B59980C0130C* and B59990C*)
- UL approval for T_{ref} = 120 °C and 130 °C to UL 1434 with $V_{max} = 65 \text{ V}$ and $V_{B} = 63 \text{ V}$ (file number E69802)
- UL approval for $T_{ref} = 80$ °C to UL 1434 with $V_{max} = 63 \text{ V}$ and $V_{B} = 50 \text{ V}$ (file number E69802)
- VDE approval for selected types (license number 104843 E)
- RoHS-compatible

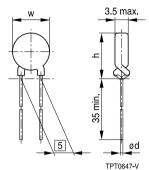
Options

- Leadless disks and leaded disks without coating available on request
- Thermistors with diameter w ≤11.0 mm are also available on tape (to IEC 60286-2)

Delivery mode

- Cardboard strips (standard)
- Cardboard tape reeled or in Ammo pack on request

Dimensional drawing



Dimensions (mm)

Туре	T _{ref} °C	W _{max}	h _{max}	Ød
C910	130	22.0	25.5	0.8
C930	80	22.0	25.5	0.6
C930	120	22.0	25.5	0.6
C930	130	17.5	21.0	0.8
C940	80	17.5	21.0	0.6
C940	120	17.5	21.0	0.6
C950	80	13.5	17.0	0.6
C950	120	13.5	17.0	0.6
C950	130	11.0	14.5	0.6
C960	80	11.0	14.5	0.6
C960	120	11.0	14.5	0.6
C960	130	9.0	12.5	0.6
C970	80	9.0	12.5	0.6
C970	120	9.0	12.5	0.6
C970	130	6.5	10.0	0.6
C980	80	6.5	10.0	0.6
C980	120	6.5	10.0	0.6
C980	130	4.0	7.5	0.6
C990	80	4.0	7.5	0.5
C990	120	4.0	7.5	0.5



Overcurrent protection	
Leaded disks, coated, 63 V	C910 C990

General technical data

Max. operating voltage	(T _A = 60 °C)	V_{max}	80	V DC or V AC
Rated voltage		V_R	63	V DC or V AC
Switching cycles		N	100	
Tolerance of R _R	$(T_{ref} = 80 ^{\circ}\text{C or } 120 ^{\circ}\text{C})$	ΔR_R	±25	%
Tolerance of R _R	(T _{ref} = 130 °C)	ΔR_{R}	±20	%
Operating temperature range	(V = 0)	T_{op}	-40/+125	°C
Operating temperature range	$(V = V_{max}, T_{ref} = 80 ^{\circ}C)$	T_{op}	-40/+85	°C
Operating temperature range	$(V = V_{max}, T_{ref} = 120 ^{\circ}\text{C}/130 ^{\circ}\text{C})$	T _{op}	-40/+125	°C

Electrical specifications and ordering codes

Туре	I _B	Is	I _{Smax}	I _r	T_{ref}	R _B	R_{min}	Appro	nvals	Ordering code
Турс	-n	-3	$(V = V_{max})$	(typ.)	(typ.)			Appro	vaio	Ordering dode
			(V — V max)	$(V = V_{max})$	(typ.)					
	mA	mA	Α	mA	°C	Ω	Ω	71	\triangle	
	ША	IIIA	^	IIIA	C	52	52	74	₽	
C910	1000	1500	10.0	60	130	1.2	0.8	Х	_	B59910C0130A070
C930	700	1400	10.0	50	120	1.65	1.1	Х	_	B59930C0120A070
C930	700	1100	8.0	50	130	2.2	1.5	Х	_	B59930C0130A070
C940	450	900	8.0	40	120	2.3	1.5	Х	_	B59940C0120A070
C930	340	700	10.0	35	80	1.65	1.1	Х	_	B59930C0080A070
C950	320	640	5.5	30	120	3.7	2.4	Х	_	B59950C0120A070
C950	320	500	4.3	25	130	4.9	3.2	Χ	_	B59950C0130A070
C960	250	500	4.3	25	120	5.6	3.7	Х	_	B59960C0120A070
C960	250	380	3.0	20	130	8.0	5.2	Х	_	B59960C0130A070
C940	245	500	8.0	25	80	2.3	1.5	Х	Х	B59940C0080A070
C950	170	350	5.5	20	80	3.7	2.4	Х	Х	B59950C0080A070
C970	150	300	3.0	20	120	9.4	6.2	Х	_	B59970C0120A070
C970	150	240	1.0	18	130	20	13.2	Х	Х	B59970C0130A070
C960	130	265	4.3	15	80	5.6	3.7	Х	Х	B59960C0080A070
C970	90	190	3.0	11	80	9.4	6.2	Х	Х	B59970C0080A070
C980	85	170	1.0	16	120	25	16.5	Х	_	B59980C0120A070
C980	85	130	0.7	15	130	62	40.9	Χ	Х	B59980C0130A070
C980	50	110	1.0	8	80	25	16.5	Χ	Х	B59980C0080A070
C990	50	100	0.7	12	120	55	36.3	Х	_	B59990C0120A070
C990	30	60	0.7	5	80	55	36.3	Χ	Χ	B59990C0080A070



Overcurrent protection	
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Reliability data

Test	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Electrical endurance,	IEC 60738-1	Room temperature, I _{Smax} ; V _{max}	< 25%
cycling		Number of cycles: 100	
Electrical endurance,	IEC 60738-1	Storage at V _{max} /T _{op,max} (V _{max})	< 25%
constant		Test duration: 1000 h	
Damp heat	IEC 60738-1	Temperature of air: 40 °C	< 10%
		Relative humidity of air: 93%	
		Duration: 56 days	
		Test according to IEC 60068-2-78	
Rapid change	IEC 60738-1	$T_1 = T_{op,min} (0 \text{ V}), T_2 = T_{op,max} (0 \text{ V})$	< 10%
of temperature		Number of cycles: 5	
		Test duration: 30 min	
		Test according to IEC 60068-2-14, test Na	
Vibration	IEC 60738-1	Frequency range: 10 to 55 Hz	< 5%
		Displacement amplitude: 0.75 mm	
		Test duration: 3 × 2 h	
		Test according to IEC 60068-2-6, test Fc	
Shock	IEC 60738-1	Acceleration: 390 m/s ²	< 5%
		Pulse duration: 6 ms; 6 × 4000 pulses	
Climatic sequence	IEC 60738-1	Dry heat: $T = T_{op,max}(0 \text{ V})$	< 10%
		Test duration: 16 h	
		Damp heat first cycle	
		Cold: $T = T_{op,min} (0 \text{ V})$	
		Test duration: 2 h	
		Damp heat 5 cycles	
		Tests performed according to	
		IEC 60068-2-30	

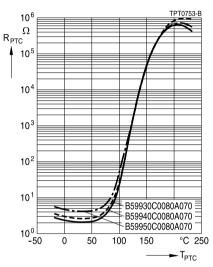


Leaded disks, coated, 63 V

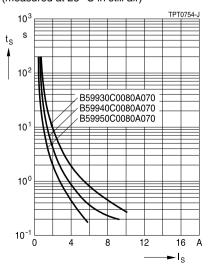
C910 ... C990

Characteristics (typical) for T_{ref} = 80 °C

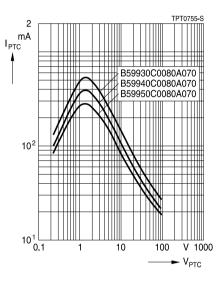
PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)



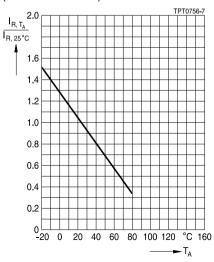
Switching time t_s versus switching current I_s (measured at 25 °C in still air)



PTC current I_{PTC} versus PTC voltage V_{PTC} (measured at 25 °C in still air)



Rated current I_R versus ambient temperature T_A (measured in still air)



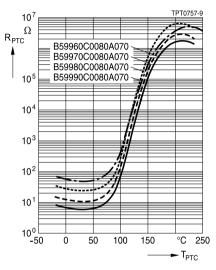


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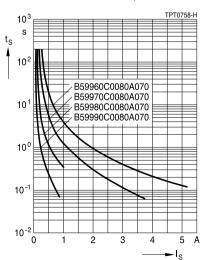
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Characteristics (typical) for T_{ref} = 80 °C

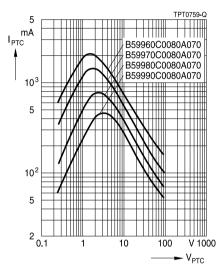
PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)



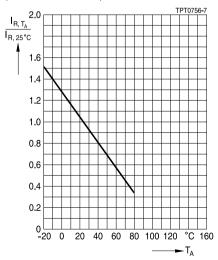
Switching time t_S versus switching current I_S (measured at 25 °C in still air)



PTC current I_{PTC} versus PTC voltage V_{PTC} (measured at 25 °C in still air)



Rated current I_R versus ambient temperature T_A (measured in still air)



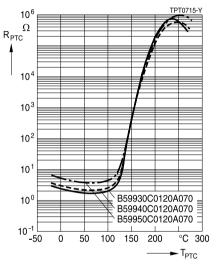


Leaded disks, coated, 63 V

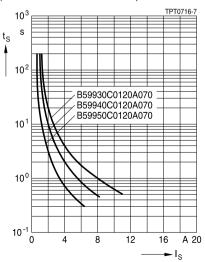
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Characteristics (typical) for T_{ref} = 120 °C

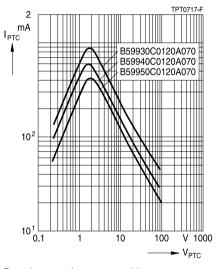
PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)



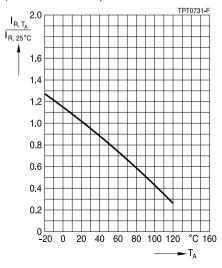
Switching time t_S versus switching current I_S (measured at 25 °C in still air)



PTC current I_{PTC} versus PTC voltage V_{PTC} (measured at 25 °C in still air)



Rated current I_R versus ambient temperature T_A (measured in still air)



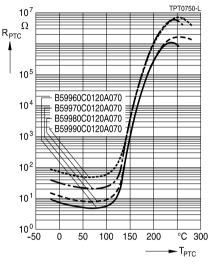


Leaded disks, coated, 63 V

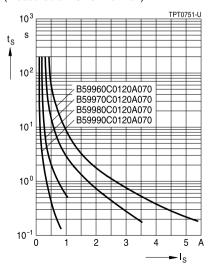
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Characteristics (typical) for T_{ref} = 120 °C

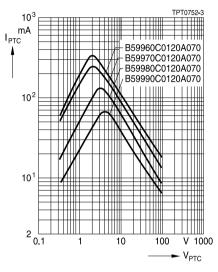
PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)



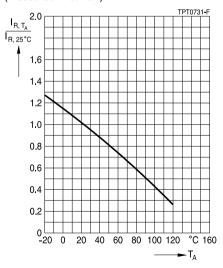
Switching time ts versus switching current Is (measured at 25 °C in still air)



PTC current I_{PTC} versus PTC voltage V_{PTC} (measured at 25 °C in still air)



Rated current I_R versus ambient temperature T_A (measured in still air)



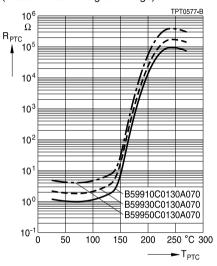


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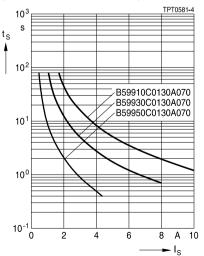
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Characteristics (typical) for T_{ref} = 130 °C

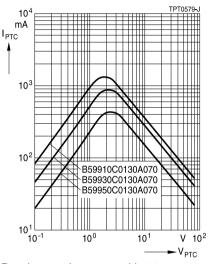
PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)



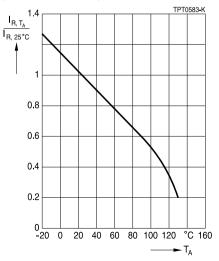
Switching time t_{S} versus switching current I_{S} (measured at 25 °C in still air)



PTC current I_{PTC} versus PTC voltage V_{PTC} (measured at 25 °C in still air)



Rated current I_R versus ambient temperature T_A (measured in still air)



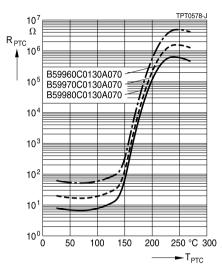


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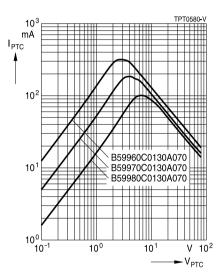
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Characteristics (typical) for T_{ref} = 130 °C

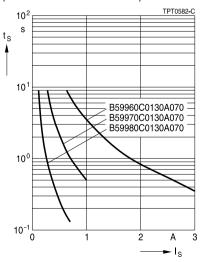
PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)



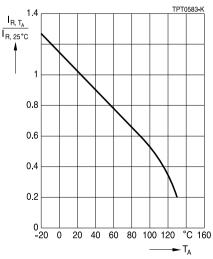
PTC current I_{PTC} versus PTC voltage V_{PTC} (measured at 25 °C in still air)



Switching time t_{S} versus switching current I_{S} (measured at 25 °C in still air)



Rated current I_R versus ambient temperature T_A (measured in still air)





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Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package before storage.
- Storage conditions in original packaging: storage temperature −25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
 - Through-hole devices (housed and leaded PTCs): 24 months
 - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
 - Telecom pair and quattro protectors (TPP, TQP): 24 months
 - Leadless PTC thermistors for pressure contacting: 12 months
 - Leadless PTC thermistors for soldering: 6 months
 - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
 - SMDs in EIA sizes 0402, 0603, 0805 and 1210: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- Components must not be touched with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.

Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.



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Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force of the clamping contacts pressing against the PTC must be 10 N.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).



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Symbols and terms

A Area

C Capacitance
C_{th} Heat capacity
f Frequency
I Current

 $\begin{array}{lll} I_{max} & & Maximum current \\ I_{R} & & Rated current \\ I_{res} & & Residual current \\ I_{PTC} & & PTC current \\ I_{r} & & Residual currrent \end{array}$

 $I_{r,oil}$ Residual currrent in oil (for level sensors) $I_{r,air}$ Residual currrent in air (for level sensors) I_{RMS} Root-mean-square value of current

I_S Switching current

I_{Smax} Maximum switching current LCT Lower category temperature

N Number (integer)

 N_c Operating cycles at V_{max} , charging of capacitor

N_f Switching cycles at V_{max}, failure mode

P Power

P₂₅ Maximum power at 25 °C

P_{el} Electrical powerP_{diss} Dissipation power

R_G Generator internal resistance

Resistance at 25 °C

 $\begin{array}{lll} R_{\text{min}} & & \text{Minimum resistance} \\ R_{\text{R}} & & \text{Rated resistance} \\ \Delta R_{\text{R}} & & \text{Tolerance of R}_{\text{R}} \\ R_{\text{P}} & & \text{Parallel resistance} \\ R_{\text{PTC}} & & \text{PTC resistance} \\ R_{\text{ref}} & & \text{Reference resistance} \\ R_{\text{S}} & & \text{Series resistance} \end{array}$

Resistance matching per reel/ packing unit at 25 °C

 ΔR_{25} Tolerance of R_{25} T Temperature

t Time

 T_A Ambient temperature t_a Thermal threshold time

 R_{25}



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 $\begin{array}{ll} T_{\text{C}} & & \text{Ferroelectric Curie temperature} \\ t_{\text{E}} & & \text{Settling time (for level sensors)} \end{array}$

 T_{R} Rated temperature T_{sense} Sensing temperature T_{op} Operating temperature T_{PTC} PTC temperature T_{R} Response time

T_{ref} Reference temperature

T_{Rmin} Temperature at minimum resistance

t_s Switching time

T_{surf} Surface temperature

UCT Upper category temperature

 $\begin{array}{ll} \text{V or V}_{\text{el}} & \text{Voltage (with subscript only for distinction from volume)} \\ \text{V}_{\text{c/max}\text{l}} & \text{Maximum DC charge voltage of the surge generator} \end{array}$

V_{E,max} Maximum voltage applied at fault conditions in protection mode

V_{RMS} Root-mean-square value of voltage

 $\begin{array}{lll} V_{\text{BD}} & & \text{Breakdown voltage} \\ V_{\text{ins}} & & \text{Insulation test voltage} \\ V_{\text{link,max}} & & \text{Maximum link voltage} \\ V_{\text{max}} & & \text{Maximum operating voltage} \end{array}$

V_{max.dvn} Maximum dynamic (short-time) operating voltage

V_{meas} Measuring voltage

V_{meas,max} Maximum measuring voltage

V_B Rated voltage

V_{PTC} Voltage drop across a PTC thermistor

 α Temperature coefficient Δ Tolerance, change δ_{th} Dissipation factor

τ_{th} Thermal cooling time constant

λ Failure rate

e Lead spacing (in mm)

Abbreviations / Notes

SMD Surface-mount devices

- * To be replaced by a number in ordering codes, type designations etc.
- + To be replaced by a letter

All dimensions are given in mm.

The commas used in numerical values denote decimal points.



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order.
 - We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
- 6. Unless otherwise agreed in individual contracts, all orders are subject to our General Terms and Conditions of Supply.
- 7. Our manufacturing sites serving the automotive business apply the IATF 16949 standard. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that only requirements mutually agreed upon can and will be implemented in our Quality Management System. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
- 8. The trade names EPCOS, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

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